



Integrated Device Technology, Inc.

16-BIT CMOS CASCADABLE ALU

IDT7381
IDT7383

FEATURES:

- High-performance 16-bit Arithmetic Logic Unit (ALU)
- 16ns to 55ns clocked ALU operations
- Ideal for radar, sonar or image processing applications
- IDT7381:
 - 54/74S381 instruction set (8 functions)
 - Replaces Gould S614381 or Logic Devices L4C381
 - Cascadable with or without carry look-ahead
- IDT7383:
 - 32 advanced ALU functions
 - Cascadable without carry look-ahead
- Pipeline or flow-through modes
- Internal feedback path for accumulation
- Three-state outputs
- TTL-compatible
- Produced with advanced submicron CMOS technology
- Available in 68-lead PGA, 68-pin surface mount PLCC and 68-pin fine-pitch Flatpack (7383 only)
- Military product compliant to MIL-STD-883, Class B
- Speeds available:
 - Commercial: L/16/20/25/30/40/55
 - Military: L/20/25/30/35/45/65

DESCRIPTION:

The IDT7381 and IDT7383 are high-speed cascadable Arithmetic Logic Unit (ALUs). Both three-bus devices have two input registers, ultra-fast 16-bit ALUs and 16-bit output registers. With IDT's high-performance CMOS technology, the IDT7381/7383 can do arithmetic or logic operations in 20ns. The IDT7381 functionally replaces four 54/74S381 four-bit ALUs in a 68-pin package.

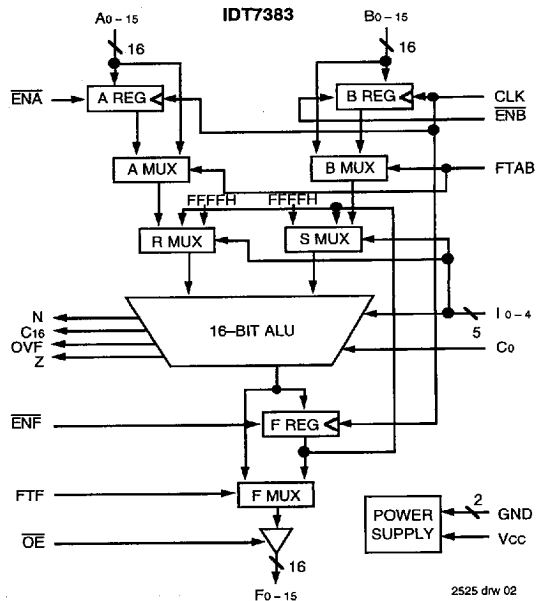
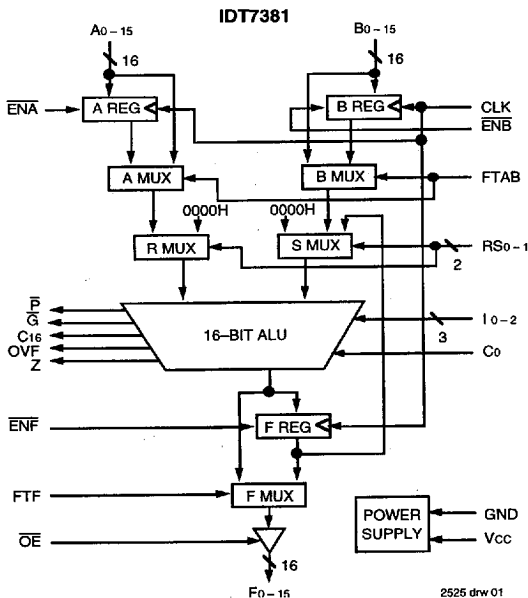
The two input operands, A and B, can be clocked or fed through for flexible pipelining. The F output can also be set into clocked or flow-through mode. An output enable is provided for three-state control of the output port on a bus.

The IDT7381 has three function pins to select 1 of 8 arithmetic or logic operations. The two R and S selection pins determine whether A, B, F or 0 are fed into the ALU. This ALU has carry-out, propagate and generate outputs for cascading using carry look-ahead.

The IDT7383 has five function pins to select 1 of 32 arithmetic or logic operations. This ALU has a carry-out pin for cascading.

The IDT7381 and IDT7383 are available in 68-pin PLCC or PGA packages. Military grade product is manufactured in compliance with the latest revision of MIL-STD-883, Class B, for high reliability systems.

FUNCTIONAL BLOCK DIAGRAM



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MILITARY AND COMMERCIAL TEMPERATURE RANGES

JULY 1996

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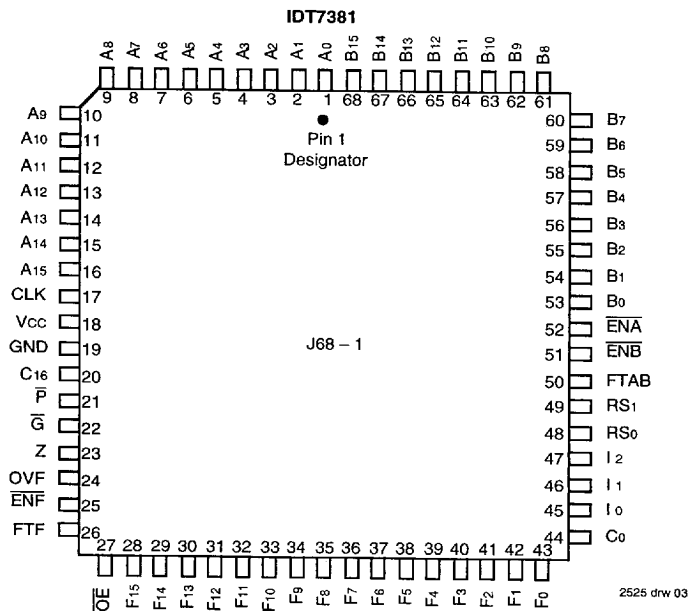
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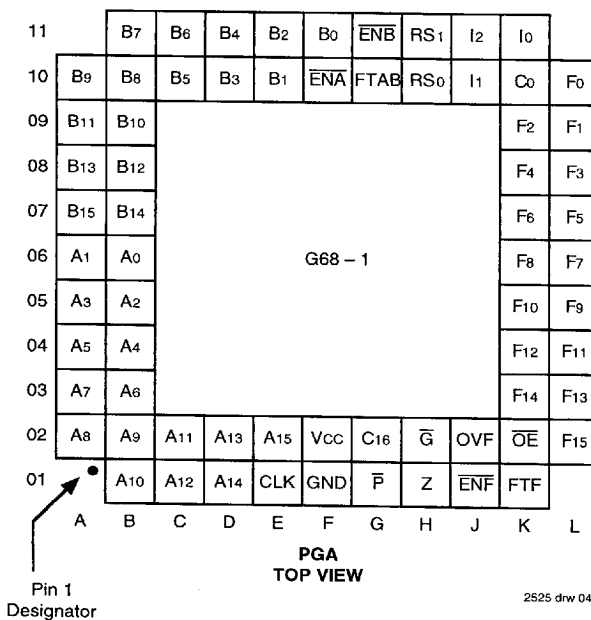
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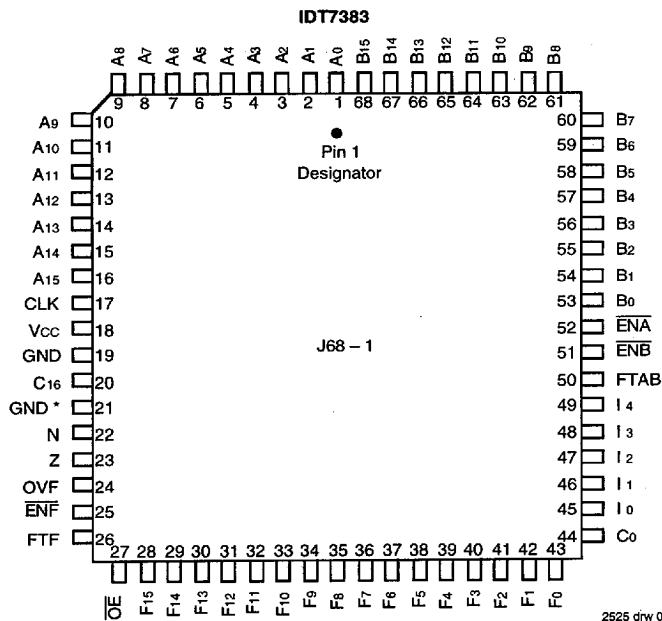
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PIN CONFIGURATION

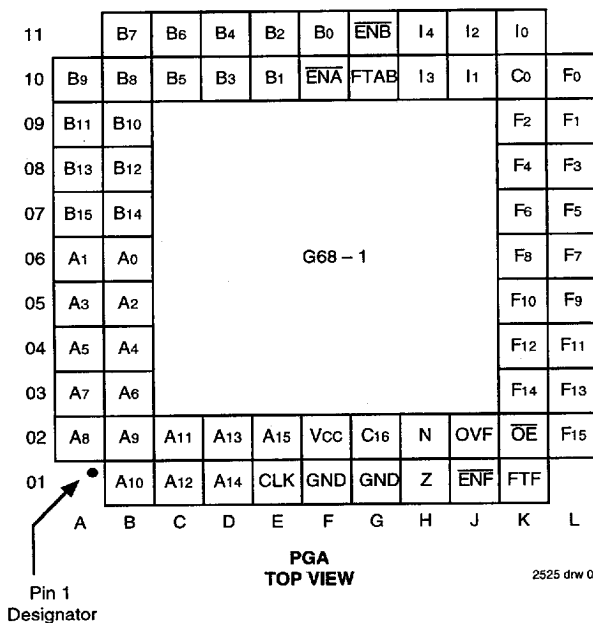


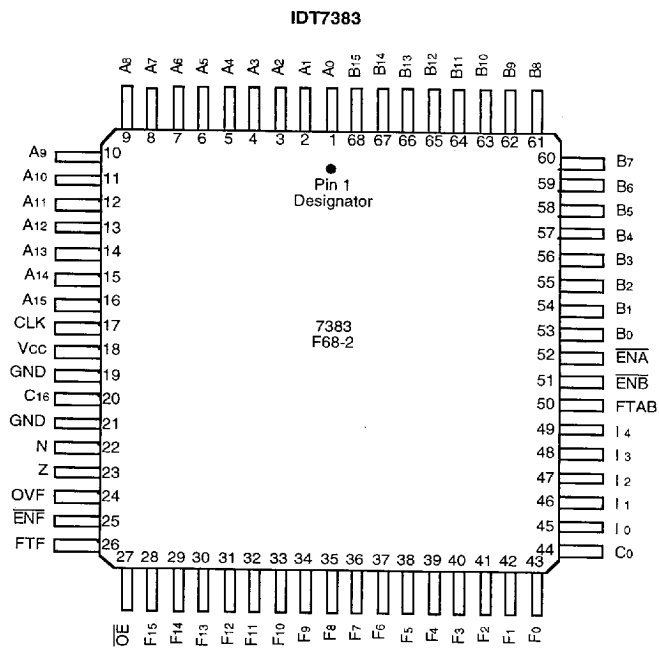
**PLCC
TOP VIEW**





**PLCC
TOP VIEW**





**FINE PITCH FLATPACK
TOP VIEW**

PIN DESCRIPTIONS

IDT7381 AND IDT7383 PIN DESCRIPTION

Pin Name	I/O	Description
A0 - A15	I	Sixteen-bit data input port.
B0 - B15	I	Sixteen-bit data input port.
ENA	I	Register enable for the A input port; active low pin.
ENB	I	Register enable for the B input port; active low pin.
FTAB	I	Flow-through control pin. When this pin is high, both register A and B are transparent.
F0 - F15	O	Sixteen-bit data output port.
ENF	I	Register enable for the F output port; active low pin.
FTF	I	Flow-through control pin. When this pin is high, the F register is transparent.
CLK	I	Clock input.
OE	I	Output enable control pin. When this pin is high, the output port F is in a high impedance state. When low, the output port F is active.
C0	I	Carry input. This pin receives arithmetic carries from less significant ALU components in a cascade configuration.
C16	O	Carry output. This pin produces arithmetic carries to more significant ALU components in a cascaded configuration.
OVF	O	This pin indicates a two's complement arithmetic overflow, when high.
Z	O	This pin indicates a zero output result, when high.
Vcc		Power supply pin, 5V.
GND		Ground pin, 0V. There are two ground pins on the IDT7383.

2525 tbl 01

IDT7381 PINS

Pin Name	I/O	Description
RS0 - RS1	I	Two control pins used to select input operands for the R and S multiplexers.
I0 - I2	I	Three control pins to select the ALU function performed.
P	O	Indicates the carry propagate output state to the ALU.
G	O	Indicates the carry generate output state to the ALU.

2525 tbl 02

IDT7383 PINS

Pin Name	I/O	Description
I0 - I4	I	Five control pins to select the ALU function performed.
N	O	The sign bit of an ALU operation.

2525 tbl 05

IDT7381 R AND S MUX TABLE

RS1	RS0	R Mux	S Mux
0	0	A	F
0	1	A	0
1	0	0	B
1	1	A	B

2525 tbl 03

IDT7381 ALU FUNCTION TABLE

I2	I1	I0	Function
0	0	0	$F = 0$
0	0	1	$F = \bar{R} + S + C_0$
0	1	0	$F = R + \bar{S} + C_0$
0	1	1	$F = R + S + C_0$
1	0	0	$F = R \text{ xor } S$
1	0	1	$F = R \text{ or } S$
1	1	0	$F = R \text{ and } S$
1	1	1	$F = \text{all 1's}$

2525 tbl 04

IDT7383 ALU FUNCTION TABLE

I4	I3	I2	I1	I0	Function
0	0	0	0	0	$F = A + B + C_0$
0	0	0	0	1	$F = A \text{ or } B$
0	0	0	1	0	$F = A + \overline{B} + C_0$
0	0	0	1	1	$F = \overline{A} + B + C_0$
0	0	1	0	0	$F = A + C_0$
0	0	1	0	1	$F = \overline{A} \text{ or } F$
0	0	1	1	0	$F = A - 1 + C_0$
0	0	1	1	1	$F = \overline{A} + C_0$
0	1	0	0	0	$F = A + F + C_0$
0	1	0	0	1	$F = A \text{ or } F$
0	1	0	1	0	$F = A + \overline{F} + C_0$
0	1	0	1	1	$F = \overline{A} + F + C_0$
0	1	1	0	0	$F = F + B + C_0$
0	1	1	0	1	$F = \overline{A} \text{ or } B$
0	1	1	1	0	$F = F + \overline{B} + C_0$
0	1	1	1	1	$F = \overline{F} + B + C_0$
1	0	0	0	0	$F = A \text{ xor } B$
1	0	0	0	1	$F = A \text{ and } B$
1	0	0	1	0	$F = \overline{A} \text{ and } B$
1	0	0	1	1	$F = A \text{ xnor } B$
1	0	1	0	0	$F = A \text{ xor } F$
1	0	1	0	1	$F = A \text{ and } F$
1	0	1	1	0	$F = \overline{A} \text{ and } F$
1	0	1	1	1	$F = \text{all } 1\text{'s} + C_0$
1	1	0	0	0	$F = B + C_0$
1	1	0	0	1	$F = A \text{ and } \overline{B}$
1	1	0	1	0	$F = \overline{B} + C_0$
1	1	0	1	1	$F = B - 1 + C_0$
1	1	1	0	0	$F = F + C_0$
1	1	1	0	1	$F = A \text{ or } \overline{B}$
1	1	1	1	0	$F = F - 1 + C_0$
1	1	1	1	1	$F = \overline{F} + C_0$

2525 tbi 06

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Rating	Com'l.	Mil.	Unit
VTERM	Terminal Voltage with Respect to Ground	-0.5 to Vcc + 0.5	-0.5 to Vcc + 0.5	V
Vcc	Power Supply Voltage	-0.5 to +7.0	-0.5 to +7.0	V
TA	Operating Temperature	0 to +70	-55 to +125	°C
TBIAS	Temperature Under Bias	-55 to +125	-65 to +135	°C
TSTG	Storage Temperature	-55 to +125	-65 to +150	°C
PT	Power Dissipation	1.0	1.0	W
IOUT	DC Output Current	50	50	mA

NOTE:

2525 tbi 07

1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Under no circumstances should an input of an I/O Pin be greater than Vcc + 0.5V.

CAPACITANCE (TA = +25°C, f = 1.0MHz)

Symbol	Parameter ⁽¹⁾	Conditions	Pkg.	Typ.	Unit
CIN	Input Capacitance	VIN = 0V	PGA	10	pF
			Flatpack	2.5	
			PLCC	5	
COUT	Output Capacitance	VOUT = 0V	PGA	12	pF
			Flatpack	4	
			PLCC	7	

NOTE:

2525 tbi 09

1. This parameter is sampled at initial characterization and is not production tested.

DC ELECTRICAL CHARACTERISTICS

Commercial: $T_A = 0^{\circ}\text{C}$ to $+70^{\circ}\text{C}$, $V_{CC} = 5.0\text{V} \pm 5\%$; Military: $T_A = -55^{\circ}\text{C}$ to $+125^{\circ}\text{C}$, $V_{CC} = 5.0\text{V} \pm 10\%$

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Typ. ⁽²⁾	Max.	Unit
V_{IH}	Input HIGH Level	Guaranteed Logic HIGH Level		2.0	—	—	V
V_{IL}	Input LOW Level	Guaranteed Logic LOW Level		—	—	0.8	V
I_{IH}	Input HIGH Current	$V_{CC} = \text{Max.}, V_{IN} = 2.7\text{V}$		—	—	10	μA
I_{IL}	Input LOW Current	$V_{CC} = \text{Max.}, V_{IN} = 0.5\text{V}$		—	—	-10	μA
$I_{OS}^{(3)}$	Short Circuit Current	$V_{CC} = \text{Max.}, V_{OUT} = \text{GND}$		-20	—	-100	mA
I_{OZ}	Off State (High Impedance)	$V_{CC} = \text{Max.}$	$V_O = 0.5\text{V}$	—	-0.1	-20	μA
	Output Current		$V_O = 2.7\text{V}$	—	-0.1	20	
V_{OH}	Output HIGH Voltage	$V_{CC} = \text{Min.}$ $V_{IN} = V_{IH}$ or V_{IL}	$I_{OH} = -4\text{mA}$	2.4	—	—	V
V_{OL}	Output LOW Voltage	$V_{CC} = \text{Min.}$ $V_{IN} = V_{IH}$ or V_{IL}	$I_{OL} = 4\text{mA MIL.}$	—	—	0.5	V
			$I_{OL} = 8\text{mA COM'L.}$				

NOTES:

1. For conditions shown as Max. or Min., use appropriate value specified under Electrical Characteristics for the applicable device type.
2. Typical values are at $V_{CC} = 5.0\text{V}$, $+25^{\circ}\text{C}$ ambient and maximum loading.
3. Not more than one output should be shorted at one time. Duration of the short circuit test should not exceed one second.

2525 tbl 08

POWER SUPPLY CHARACTERISTICS

Commercial: $T_A = 0^{\circ}\text{C}$ to $+70^{\circ}\text{C}$, $V_{CC} = 5.0\text{V} \pm 5\%$; Military: $T_A = -55^{\circ}\text{C}$ to $+125^{\circ}\text{C}$, $V_{CC} = 5.0\text{V} \pm 10\%$

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Typ. ⁽²⁾	Max.	Unit
I _{cc}	Quiescent Power Supply Current	V _{CC} = Max. V _{IN} = GND or V _{CC}	COM'L. MIL.	— —	2 2	6 10	mA
ΔI _{cc} ⁽³⁾	Quiescent Power Supply Current TTL Input HIGH	V _{CC} = Max. V _{IN} = 3.4V	COM'L. MIL.	— —	0.5 0.5	1.0 1.5	mA/ input
I _{ccD} ⁽⁴⁾	Dynamic Power Supply Current	V _{CC} = Max. Outputs disabled V _{IN} = GND or V _{CC} Mode: FTAB = FTF = 1	COM'L. MIL.	— —	15 15	48 60	μA/ MHz
I _{ccD1}	Dynamic Power Supply Current	V _{CC} = Max. Outputs Disabled All Data Inputs Disabled f _i = 10MHz, f _{CP} = 10MHz 50% Duty Cycle V _{IL} = GND, V _{IH} = V _{CC} Mode: FTAB = FTF = 1	COM'L. MIL.	— —	20 20	33 40	mA
I _{ccD2} ⁽⁶⁾	Dynamic Power Supply Current	V _{CC} = Max. Outputs Enabled. (CL = 50pF) All Data Inputs Switching f _i = 10MHz, f _{CP} = 10MHz 50% Duty Cycle V _{IL} = GND, V _{IH} = V _{CC} Mode: FTAB = FTF = 1	COM'L. MIL.	— —	40 40	60 80	mA
I _C ⁽⁷⁾	Total Power Supply Current	V _{CC} = Max. V _{IN} = GND or V _{CC} All Data Inputs Switching f _i = 10MHz, f _{CP} = 10MHz 50% Duty Cycle	Outputs Disabled COM'L. MIL.	— —	22 22	39 50	mA
			Outputs Enabled COM'L. MIL.	— —	42 42	76 90	mA

NOTES:

2525 tbl 10

- For conditions shown as Max. or Min., use appropriate value specified under Electrical Characteristics for the applicable device type.
- Typical values are at V_{CC} = 5.0V, +25°C ambient.
- Per TTL driven input (V_{IN} = 3.4V); all other inputs at V_{CC} or GND.
- This parameter is not directly testable, but is derived from I_{ccD1} for use in Total Power Supply calculations.
- Total power supply current is calculated as follows:
 $I_C = I_{\text{QUIESCENT}} + I_{\text{INPUTS}} + I_{\text{DYNAMIC}}$
 $I_C = I_{CC} + \Delta I_{CC} \cdot D_H \cdot N_I + I_{CCD} (f_{CP} + f_{IN})$
 $I_{CC} = \text{Quiescent Current}$
 $\Delta I_{CC} = \text{Power Supply Current for a TTL High Input (V}_{IN} = 3.4\text{V})$
 $D_H = \text{Duty Cycle for TTL Inputs High}$
 $N_I = \text{Number of TTL Inputs at } D_H$
 $I_{CCD} = \text{Dynamic Current Caused by an Output Transition Pair (HLH or LHL)}$
 $f_{CP} = \text{Clock Frequency for Register Devices (Zero for Non-Register Devices)}$
 $f_{IN} = \text{Input Frequency}$
 $N_I = \text{Number of Inputs at } f_{IN}$
 All currents are in milliamps and all frequencies are in megahertz.
- This parameter is not production tested but is an indicator of the power dissipated with outputs loaded.
- Values for these conditions are examples of the I_C formula in note 5 above. These are guaranteed but not tested.

AC ELECTRICAL CHARACTERISTICS — COMMERCIAL ($V_{CC} = 5V \pm 5\%$, $T_A = 0^\circ C$ to $+70^\circ C$)

Maximum Combinational Propagation Delays													
From Input	IDT7381L16 IDT7383L16				IDT7381L20 IDT7383L20				IDT7381L25 IDT7383L25				Unit
	F0-15	P̄, Ḡ, N	Z,OVF	C16	F0-15	P̄, Ḡ, N	Z,OVF	C16	F0-15	P̄, Ḡ, N	Z,OVF	C16	
FTAB = 0, FTF = 0													
CLK	10	16	16	16	11	20	20	20	13	22	26	22	ns
C0	—	—	13	13	—	—	14	14	—	—	16	16	ns
lo-4, RS0, RS1 ⁽¹⁾	—	14	18	14	—	18	20	18	—	22	22	22	ns
FTAB = 0, FTF = 1													
CLK	16	16	16	16	20	20	20	20	27	22	26	22	ns
C0	14	—	13	13	18	—	14	14	22	—	16	16	ns
lo-4, RS0, RS1 ⁽¹⁾	18	14	18	14	20	18	20	18	22	22	22	22	ns
FTAB = 1, FTF = 0													
A0-A15, B0-B15	—	14	16	15	—	16	20	17	—	18	25	22	ns
CLK	10	—	—	—	11	—	—	—	13	—	—	—	ns
C0	—	—	13	13	—	—	14	14	—	—	16	16	ns
lo-4, RS0, RS1 ⁽¹⁾	—	14	18	14	—	18	20	18	—	22	22	22	ns
FTAB = 1, FTF = 1													
A0-A15, B0-B15	16	14	16	15	20	16	20	17	26	18	25	22	ns
C0	14	—	13	13	18	—	14	14	22	—	16	16	ns
lo-4, RS0, RS1 ⁽¹⁾	18	14	18	14	20	18	20	18	22	22	22	22	ns

2525 tb 11

Maximum Combinational Propagation Delays													
From Input	IDT7381L30 IDT7383L30				IDT7381L40 IDT7383L40				IDT7381L55 IDT7383L55				Unit
	F0-15	P, G, N	Z,OVF	C16	F0-15	P, G, N	Z, OVF	C16	F0-15	P, G, N	Z, OVF	C16	
FTAB = 0, FTF = 0													
CLK	20	28	30	28	26	30	44	32	32	38	53	36	ns
C0	—	—	20	20	—	—	28	20	—	—	34	22	ns
lo-4, RS0, RS1 ⁽¹⁾	—	28	28	28	—	32	34	35	—	42	42	42	ns
FTAB = 0, FTF = 1													
CLK	33	28	30	28	46	30	44	32	56	38	53	36	ns
C0	28	—	20	20	30	—	28	20	37	—	34	22	ns
lo-4, RS0, RS1 ⁽¹⁾	28	28	28	28	40	32	34	35	55	42	42	42	ns
FTAB = 1, FTF = 0													
A0-A15, B0-B15	—	24	30	28	—	30	40	32	—	36	46	37	ns
CLK	19	—	—	—	26	—	—	—	32	—	—	—	ns
C0	—	—	20	20	—	—	28	20	—	—	34	22	ns
lo-4, RS0, RS1 ⁽¹⁾	—	28	28	28	—	32	34	35	—	42	42	42	ns
FTAB = 1, FTF = 1													
A0-A15, B0-B15	32	24	30	28	40	30	40	32	55	36	46	37	ns
C0	28	—	20	20	30	—	28	20	37	—	34	22	ns
lo-4, RS0, RS1 ⁽¹⁾	28	28	28	28	40	32	34	35	55	42	42	42	ns

2525 tb 12

AC ELECTRICAL CHARACTERISTICS — COMMERCIAL (V_{CC} = 5V ± 5%, T_A = 0°C to +70°C) - (Cont'd.)

Minimum Set-up and Hold Times Relative to Clock (CLK)													
Input	IDT7381L16 IDT7383L16		IDT7381L20 IDT7383L20		IDT7381L25 IDT7383L25		IDT7381L30 IDT7383L30		IDT7381L40 IDT7383L40		IDT7381L55 IDT7383L55		Unit
	Set-up	Hold	Set-up	Hold	Set-up	Hold	Set-up	Hold	Set-up	Hold	Set-up	Hold	
FTAB = 0, FTF = X													
A0–A15, B0–B15	4	0	5	0	6	0	6	0	6	0	8	0	ns
C0 (2)	9	0	12	0	16	0	16	0	16	0	21	0	ns
I0–4, RS0, RS1 (1) (2)	11	0	15	0	24	0	29	0	32	0	44	0	ns
ENA, ENB, ENF	4	0	5	0	6	0	6	0	6	0	8	0	ns
FTAB = 1, FTF = 0													
A0–A15, B0–B15	10	0	14	0	16	0	25	0	28	0	35	0	ns
C0	9	0	12	0	16	0	16	0	16	0	21	0	ns
I0–4, RS0, RS1 (1)	11	0	15	0	24	0	29	0	32	0	44	0	ns
ENF	4	0	5	0	6	0	6	0	6	0	8	0	ns

2525 tbl 13

Minimum Clock Cycle Times and Pulse Widths							
Parameter	IDT7381L16 IDT7383L16	IDT7381L20 IDT7383L20	IDT7381L25 IDT7383L25	IDT7381L30 IDT7383L30	IDT7381L40 IDT7383L40	IDT7381L55 IDT7383L55	Unit
Clock LOW Time	5	5	6	8	10	14	ns
Clock HIGH Time	5	5	6	8	10	14	ns
Clock Period	16	18	20	25	34	43	ns

2525 tbl 14

Maximum Output Enable/Disable Times							
Parameter	IDT7381L16 IDT7383L16	IDT7381L20 IDT7383L20	IDT7381L25 IDT7383L25	IDT7381L30 IDT7383L30	IDT7381L40 IDT7383L40	IDT7381L55 IDT7383L55	Unit
Enable Time	7	8	10	15	18	20	ns
Disable Time	7	8	10	15	18	20	ns

NOTES:

1. For IDT7381, pins I₀ - I₂, RS₀, RS₁ apply. For IDT7383, pins I₀ - I₄ apply.
2. Only for FTF = 0.
3. Minimum propagation delays are not production tested but guaranteed to be greater than or equal to 3ns.

2525 tbl 15

AC ELECTRICAL CHARACTERISTICS — MILITARY ($V_{CC} = 5V \pm 10\%$, $T_A = -55^\circ C$ to $+125^\circ C$)

Maximum Combinational Propagation Delays													
From Input	IDT7381L20 IDT7383L20				IDT7381L25 IDT7383L25				IDT7381L30 IDT7383L30				Unit
	F0-15	P, G, N	Z,OVF	C16	F0-15	P, G, N	Z,OVF	C16	F0-15	P, G, N	Z,OVF	C16	
FTAB = 0, FTF = 0													
CLK	11	20	20	20	14	24	24	24	26	28	34	28	ns
Co	—	—	14	14	—	—	18	18	—	—	22	22	ns
Io-4, RS0, RS1 (1)	—	18	20	18	—	22	24	22	—	28	28	28	ns
FTAB = 0, FTF = 1													
CLK	20	20	20	20	25	24	24	24	34	28	34	28	ns
Co	18	—	14	14	21	—	18	18	26	—	22	22	ns
Io-4, RS0, RS1 (1)	20	18	20	18	25	22	24	22	30	28	28	28	ns
FTAB = 1, FTF = 0													
A0-A15, B0-B15	—	16	20	17	—	20	25	22	—	28	28	28	ns
CLK	11	—	—	—	14	—	—	—	26	—	—	—	ns
Co	—	—	14	14	—	—	18	18	—	—	22	22	ns
Io-4, RS0, RS1 (1)	—	18	20	18	—	22	24	22	—	28	28	28	ns
FTAB = 1, FTF = 1													
A0-A15, B0-B15	20	16	20	17	25	22	25	22	30	28	28	28	ns
Co	18	—	14	14	21	—	18	18	26	—	22	22	ns
Io-4, RS0, RS1 (1)	20	18	20	18	25	22	24	22	30	28	28	28	ns

2525 tb 16

Maximum Combinational Propagation Delays													
From Input	IDT7381L35 IDT7383L35				IDT7381L45 IDT7383L45				IDT7381L65 IDT7383L65				Unit
	F0-15	P, G, N	Z,OVF	C16	F0-15	P, G, N	Z, OVF	C16	F0-15	P, G, N	Z, OVF	C16	
FTAB = 0, FTF = 0													
CLK	27	32	45	32	28	34	50	34	37	44	63	45	ns
C0	—	—	30	23	—	—	32	23	—	—	42	25	ns
I0-4, RS0, RS1 (1)	—	34	34	34	—	38	38	38	—	48	48	48	ns
FTAB = 0, FTF = 1													
CLK	45	32	40	32	56	34	50	34	68	44	63	45	ns
C0	30	—	30	23	32	—	32	23	42	—	42	25	ns
I0-4, RS0, RS1 (1)	40	34	34	34	46	38	38	38	66	48	48	48	ns
FTAB = 1, FTF = 0													
A0-A15, B0-B15	—	30	35	32	—	32	46	36	—	44	56	44	ns
CLK	27	—	—	—	28	—	—	—	37	—	—	—	ns
C0	—	—	30	23	—	—	32	23	—	—	42	25	ns
I0-4, RS0, RS1 (1)	—	34	34	34	—	38	38	38	—	48	48	48	ns
FTAB = 1, FTF = 1													
A0-A15, B0-B15	40	30	30	32	45	32	46	36	65	44	56	44	ns
C0	30	—	30	23	32	—	32	23	42	—	42	25	ns
I0-4, RS0, RS1 (1)	40	34	34	34	46	38	38	38	66	48	48	48	ns

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AC ELECTRICAL CHARACTERISTICS — MILITARY (V_{CC} = 5V ± 10%, T_A = -55°C to +125°C) - (Cont'd)

Minimum Set-up and Hold Times Relative to Clock (CLK)													
Input	IDT7381L20 IDT7383L20		IDT7381L25 IDT7383L25		IDT7381L30 IDT7383L30		IDT7381L35 IDT7383L35		IDT7381L45 IDT7383L45		IDT7381L65 IDT7383L65		Unit
	Set-up	Hold	Set-up	Hold	Set-up	Hold	Set-up	Hold	Set-up	Hold	Set-up	Hold	
FTAB = 0, FTF = X													
A0–A15, B0–B15	6	0	7	0	8	0	8	0	8	0	10	0	ns
C0 (2)	12	0	14	0	18	0	19	0	20	0	25	0	ns
I0–4, RS0, RS1 (1) (2)	15	0	19	0	30	0	32	0	36	0	50	0	ns
ENA, ENB, ENF	6	0	7	0	8	0	8	0	8	0	10	0	ns
FTAB = 1, FTF = 0													
A0–A15, B0–B15	14	0	14	0	27	0	30	0	33	0	43	0	ns
C0	12	0	14	0	18	0	19	0	20	0	25	0	ns
I0–4, RS0, RS1 (1)	15	0	19	0	30	0	34	0	36	0	50	0	ns
ENF	6	0	7	0	8	0	8	0	8	0	10	0	ns

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Minimum Clock Cycle Times and Pulse Widths							
Parameter	IDT7381L20 IDT7383L20	IDT7381L25 IDT7383L25	IDT7381L30 IDT7383L30	IDT7381L35 IDT7383L35	IDT7381L45 IDT7383L45	IDT7381L65 IDT7383L65	Unit
Clock LOW Time	6	8	12	13	15	20	ns
Clock HIGH Time	6	8	12	13	15	20	ns
Clock Period	20	20	26	30	38	52	ns

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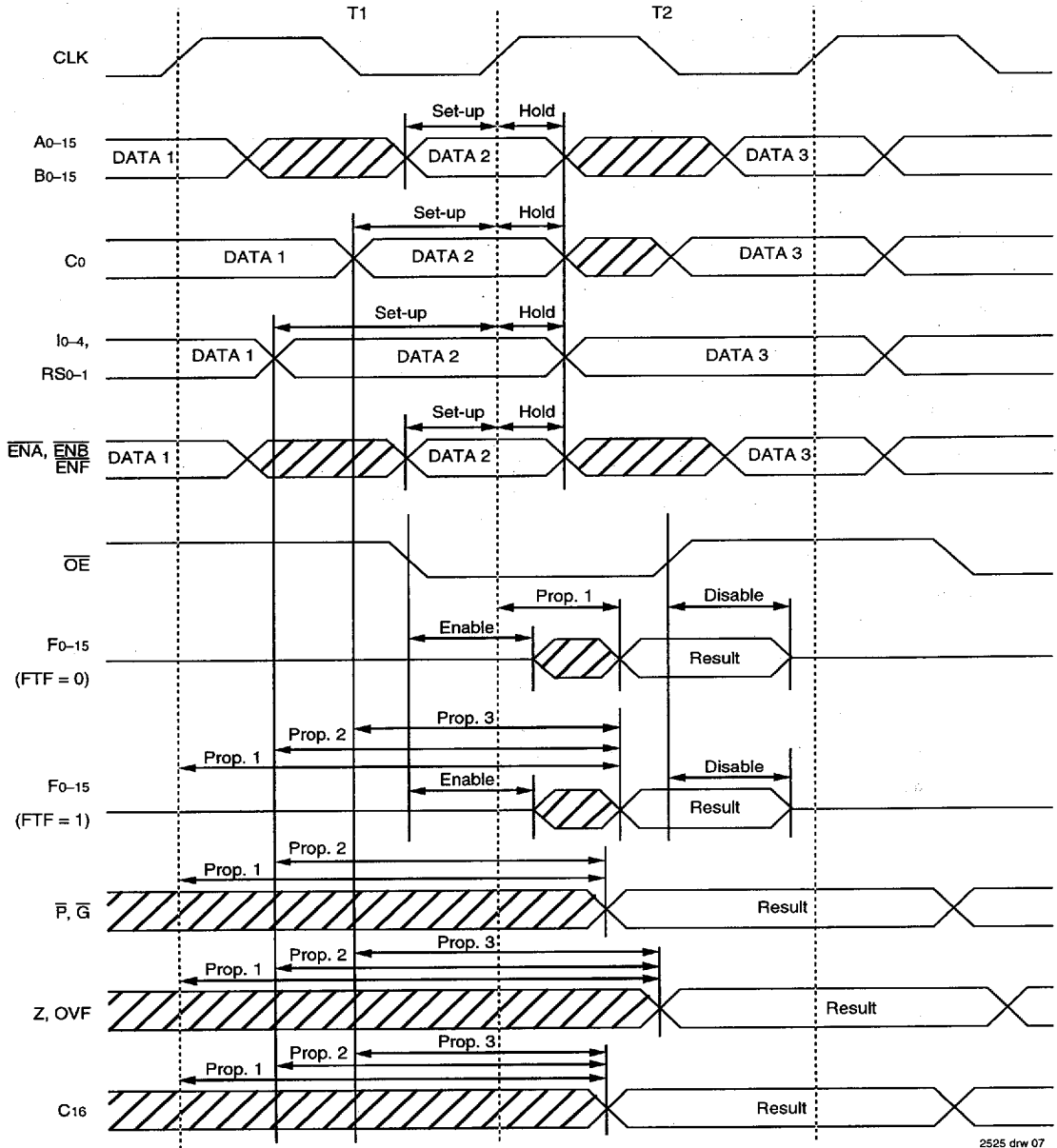
Maximum Output Enable/Disable Times							
Parameter	IDT7381L20 IDT7383L20	IDT7381L25 IDT7383L25	IDT7381L30 IDT7383L30	IDT7381L35 IDT7383L35	IDT7381L45 IDT7383L45	IDT7381L65 IDT7383L65	Unit
Enable Time	12	14	18	19	20	22	ns
Disable Time	12	14	18	19	20	22	ns

NOTES:

1. For IDT7381, pins I₀ - I₂, RS₀, RS₁ apply. For IDT7383, pins I₀ - I₄ apply.
2. Only for FTF = 0.
3. Minimum propagation delays are not production tested but guaranteed to be greater than or equal to 3ns.

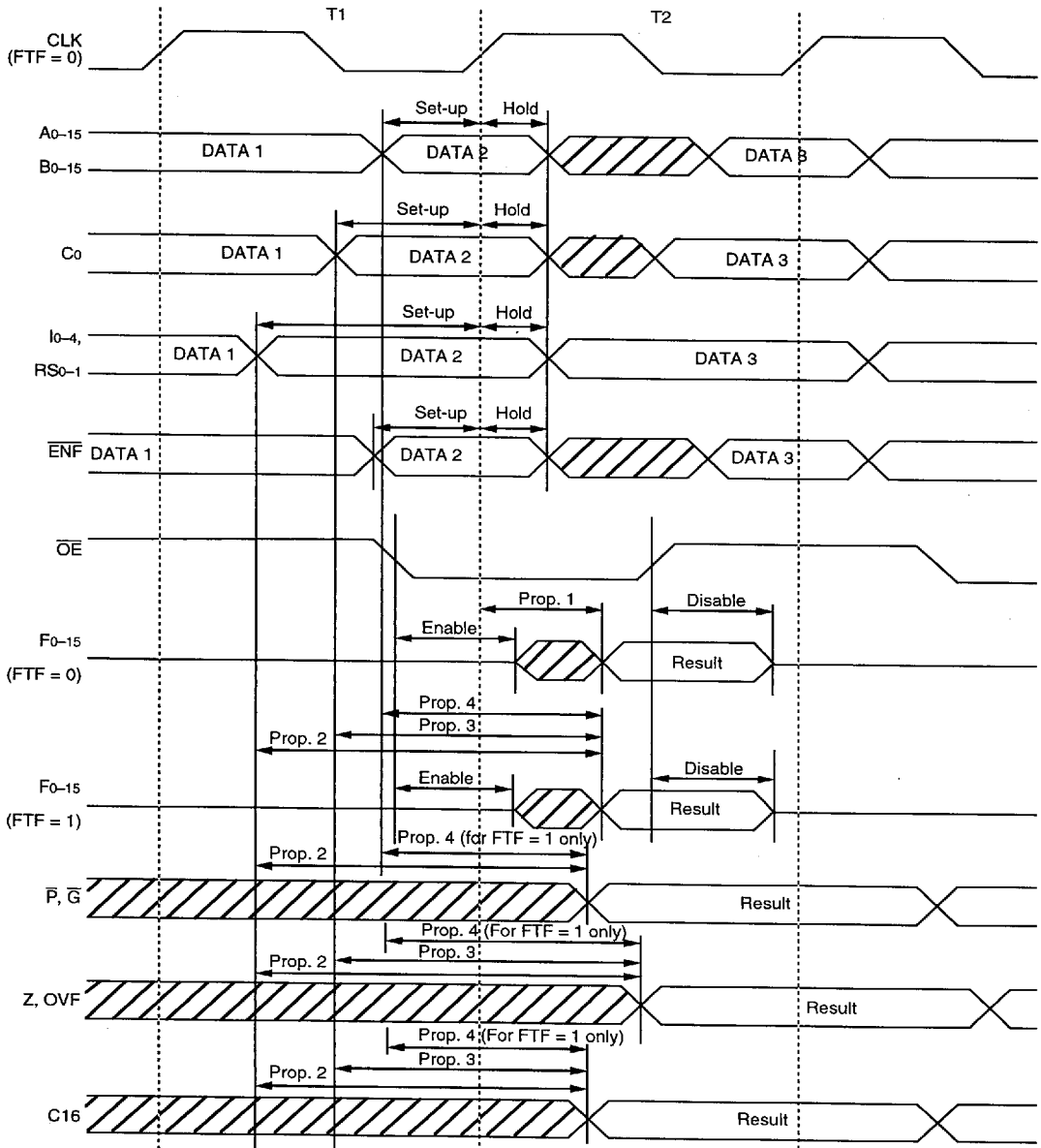
2525 tbl 20

WAVEFORMS FOR FTAB = 0, FTF = X



2525 drw 07

WAVEFORMS FOR FTAB = 1, FTF = X



2526 drw 08

PROPAGATION DELAY CALCULATIONS FOR TWO IDT7381/7383s

From Input	To Output		To Set PUT Time Relative to Clock (CLK)
	F0-15	Flags ⁽²⁾	
FTAB = 0, FTF = 0 CLK Co I0-4, RS0-1 ⁽¹⁾ A0-15, B0-15 ENA, ENB, ENF	As in 16-bit case	(Clk → C16) + (Co → flag) (Co → C16) + (Co → flag) (I0-4, RS0-1 → C16) + (Co → flag)	 (Co → C16) + (Co set-up time) (I0-4, RS0-1 → C16) + (Co set-up time) As in 16-bit case As in 16-bit case
FTAB = 0, FTF = 1 CLK Co I0-4, RS0-1 ⁽¹⁾ A0-15, B0-15 ENA, ENB, ENF	(Clk → C16) + (Co → F0-15) (Co → C16) + (Co → F0-15) (I0-4, RS0-1 → C16) + (Co → F0-15)	(Clk → C16) + (Co → flag) (Co → C16) + (Co → flag) (I0-4, RS0-1 → C16) + (Co → flag)	 (Co → C16) + (Co set-up time) (I0-4, RS0-1 → C16) + (Co set-up time) As in 16-bit case As in 16-bit case
FTAB = 1, FTF = 0 CLK Co I0-4, RS0-1 ⁽¹⁾ A0-15, B0-15 ENA, ENB, ENF	As in 16-bit case	 (Co → C16) + (Co → flag) (I0-4, RS0-1 → C16) + (Co → flag) (A0-15, B0-15 → C16) + (Co → flag)	 (Co → C16) + (Co set-up time) (I0-4, RS0-1 → C16) + (Co set-up time) As in 16-bit case As in 16-bit case
FTAB = 0, FTF = 1 CLK Co I0-4, RS0-1 ⁽¹⁾ A0-15, B0-15 ENA, ENB, ENF	Don't care condition (Co → C16) + (Co → F0-15) (I0-4, RS0-1 → C16) + (Co → F0-15) (A0-15, B0-15 → C16) + (Co → F0-15)	Don't care condition (Co → C16) + (Co → flag) (I0-4, RS0-1 → C16) + (Co → flag) (A0-15, B0-15 → C16) + (Co → flag)	

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NOTES:

1. For IDT7381, pins I0-2, RS0-2 apply. For IDT7383, pins I0-4 apply.
2. Flags are P, G, OV, Z, C16 for IDT7381. Flags are N, OV, Z, C16 for IDT7383.

CASCADING THE IDT7381/3

Some applications require 32-bit or wider input operands. Cascading is the hardware solution. It provides a high speed alternative in handling more than 16-bit wide operands.

This section is divided in three parts:

1. Cascading the IDT7381
2. Cascading the IDT7383
3. Time delay considerations

1. Cascading the IDT7381

Cascading to 32-bit wide operands takes only two IDT7381s and no external hardware. However, cascading to data widths greater than 32-bit can be done in two ways: without external hardware (slow method) or by using a carry look ahead generator like FCT182 (fast method).

a) Cascading the IDT7381 without a carry-look-ahead generator: (Figures 1 and 2)

1. Connect the C16 output of the least significant device into the Co input of the next most significant device.
2. Common lines to all devices are: RSo-1, I0-2, Clk, FTF, FTAB, ENA, ENB, ENF.
3. Take OVF, C16, $\bar{P}$, $\bar{G}$ of the most significant device as valid.
4. The system's zero flag (Z) is obtained by ANDing all zero flag results.

b) Cascading three or more IDT7381s with carry-look-ahead (CLA) generator: (Figure 3)

1. Connect the $\bar{P}$ and $\bar{G}$ outputs of each device to the CLA generator's corresponding inputs.
2. Take the CLA generator outputs into the Co inputs of each device (except for the least significant one).
3. Common lines to all devices are: RSo-1, I0-2, Clk, FTF, FTAB, ENA, ENB, ENF.
4. Take OVF, C16, $\bar{P}$, $\bar{G}$ of the most significant device as valid.
5. Carry-in to the system should be connected to the Co input of the least significant device and also to the CLA generator.

2. Cascading the IDT7383

(Figures 4 and 5)

1. Connect the C16 output of the least significant device into the Co input of the next most significant device.
2. Common lines to all devices are: I0-4, Clk, FTF, FTAB, ENA, ENB, ENF.
3. Take OVF, C16, N of the most significant device as valid.
4. The system's zero flag (Z) is obtained by ANDing all zero flag results.

3. Time Delay Considerations

Once cascading has taken place, time delays may become critical in high performance systems. Our main interest here is focused on "propagation delays", i.e. calculating the time required for an input signal to propagate through several cascaded devices up to a specific output in another device within the cascaded system.

Propagation Delay

The propagation delay for two devices between the input and output of interest (input to output delay) is done as follows:

1. Calculate delay between the input and C16 in the first device.
2. Calculate delay between Co and the output in the second device.
3. Add both results.

The following table is an example on how to build a propagation delay table for all inputs in a 32-bit IDT7381/3 cascaded system.

Propagation delay calculations can be extended to n -cascaded devices as the sum of the delays in all devices between the input and output of interest. That is:

$$(\text{Input})_1 \rightarrow (\text{C16})_1 = t_1$$

...

$$(\text{Co})_i \rightarrow (\text{C16})_i = t_i$$

$$(\text{Co})_{i+1} \rightarrow (\text{C16})_{i+1} = t_{i+1}$$

...

$$(\text{Co})_n \rightarrow (\text{Output})_n = t_n$$

Where the subscript i denotes the device number and the arrow ($\rightarrow$) represents the delay in between. Notice that $i+1$ is the immediate upper device from device i . Adding the delays t_i we get:

$$\text{Propagation delay} = t_1 + t_2 + \dots + t_i + t_{i+1} + \dots + t_n$$

Total Delay

As seen from Figure 10, the propagation delay is within the IDT7381/3 devices only. A complete analysis should also include the delay associated with the transmission line L_i (which depends on the line length and its impedance). This line delay should then be added to the propagation delay to obtain the total delay for the cascaded system:

$$\text{Total delay} = \text{Propagation delay} + \text{Transmission line delay}$$

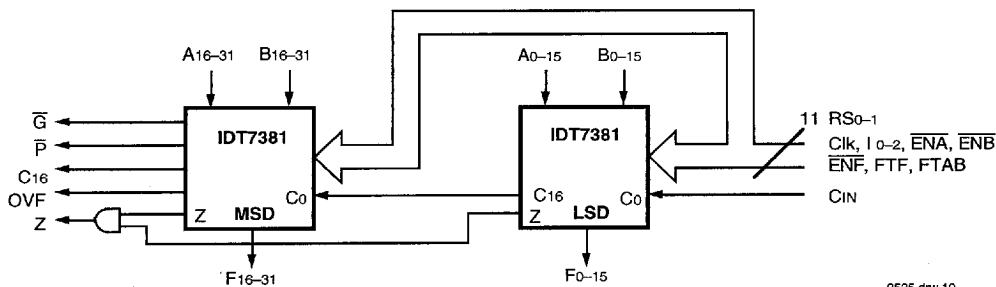


Figure 1. Cascading Two IDT7381s to 32 Bits

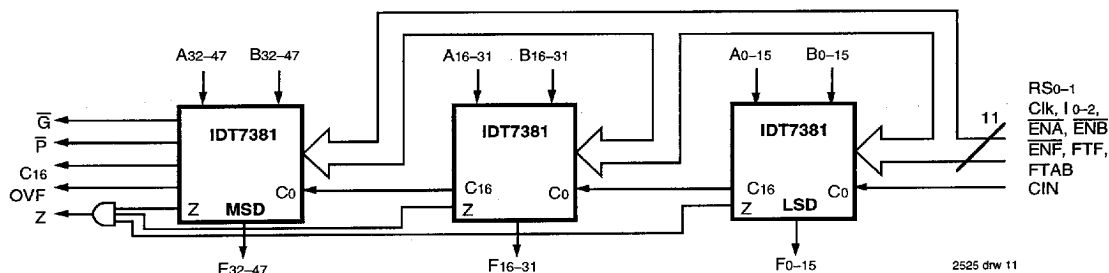


Figure 2. Cascading Three IDT7381s to 48 Bits Wide without a Carry-lookahead Generator

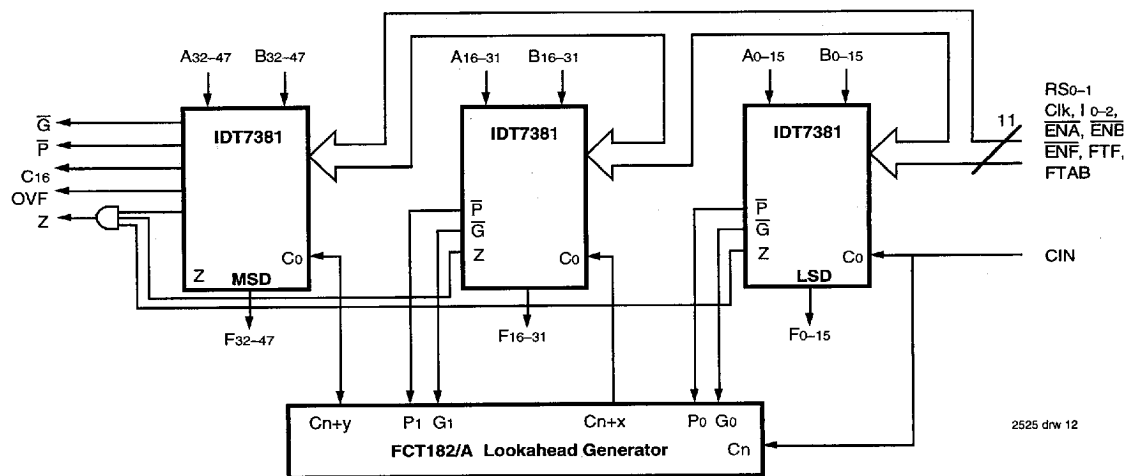


Figure 3. Cascading Three IDT7381s to 48 Bits Wide with a Carry-lookahead Generator

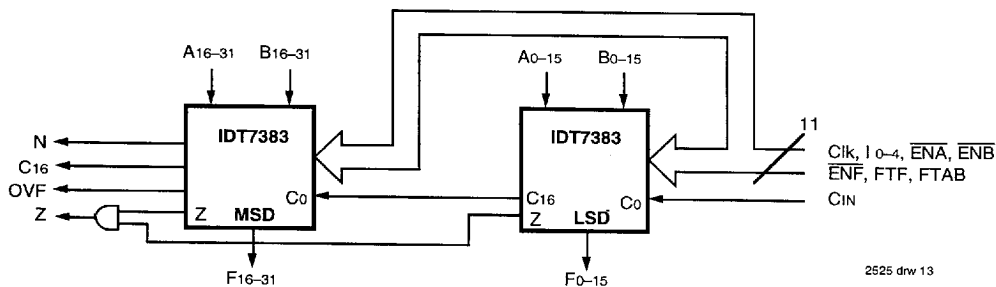


Figure 4. Cascading Two IDT7383s to 32 Bits

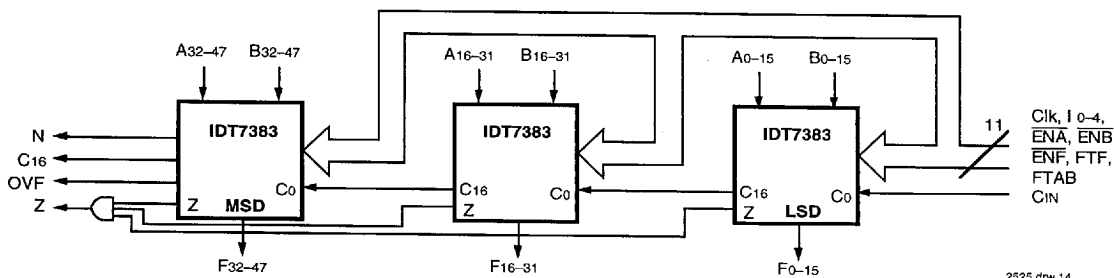


Figure 5. Cascading Three IDT7383s to 48 Bits

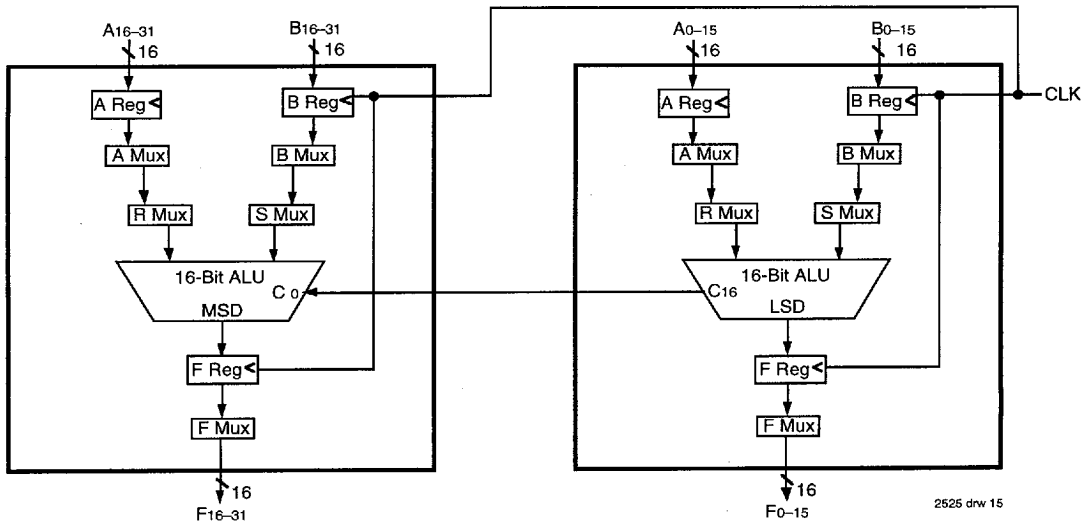


Figure 6. 32-Bit Configuration for FTAB = 0, FTF = 0

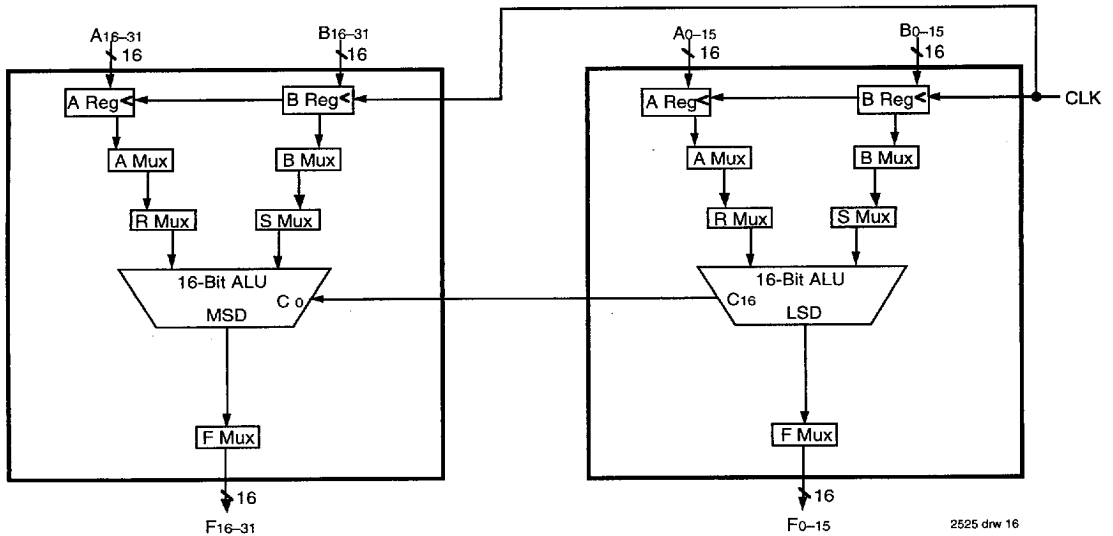


Figure 7. 32-Bit Configuration for FTAB = 0, FTF = 1

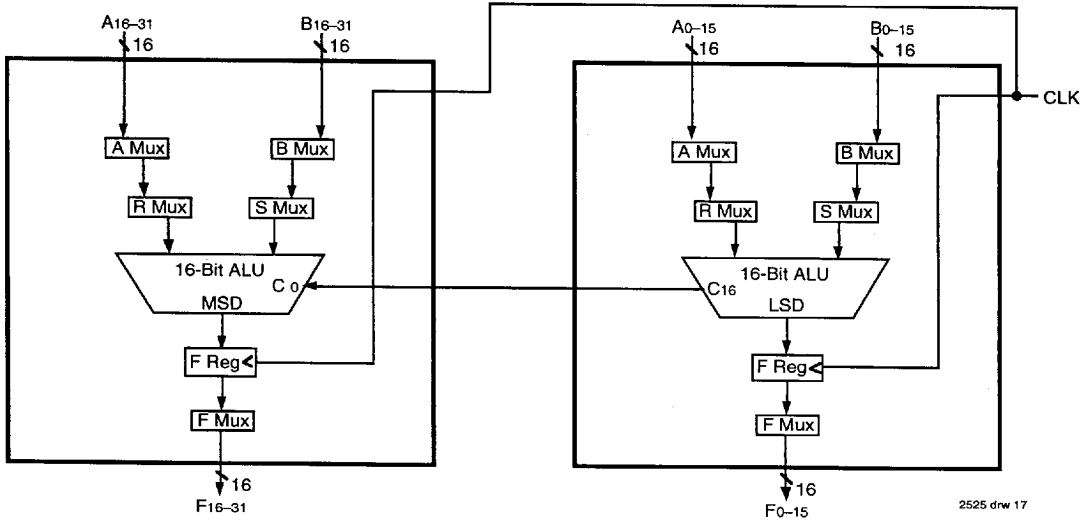


Figure 8. 32-Bit Configuration for FTAB = 1, FTF = 0

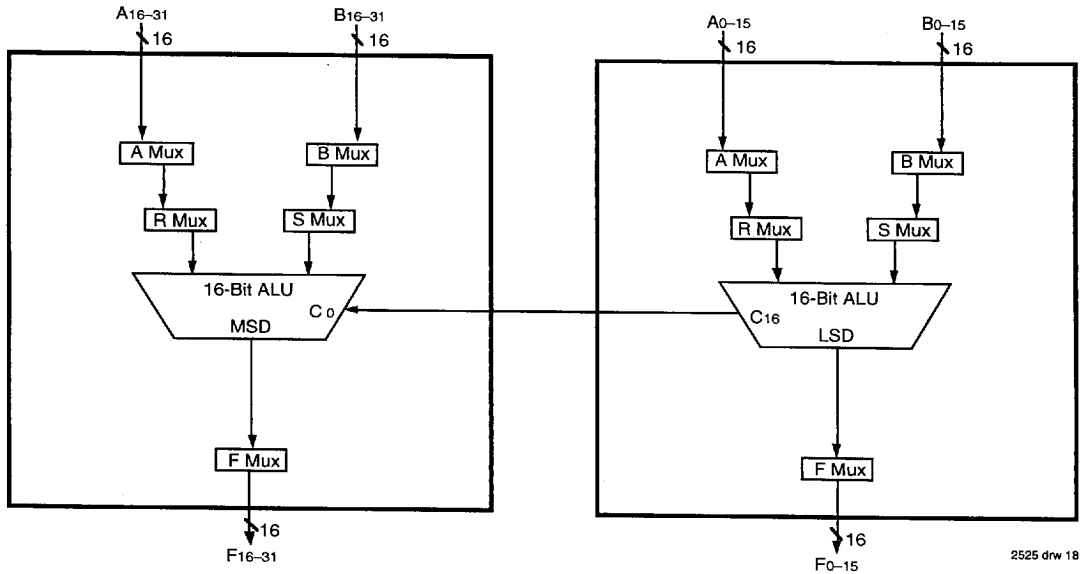


Figure 9. 32-Bit Configuration for FTAB = 1, FTF = 1

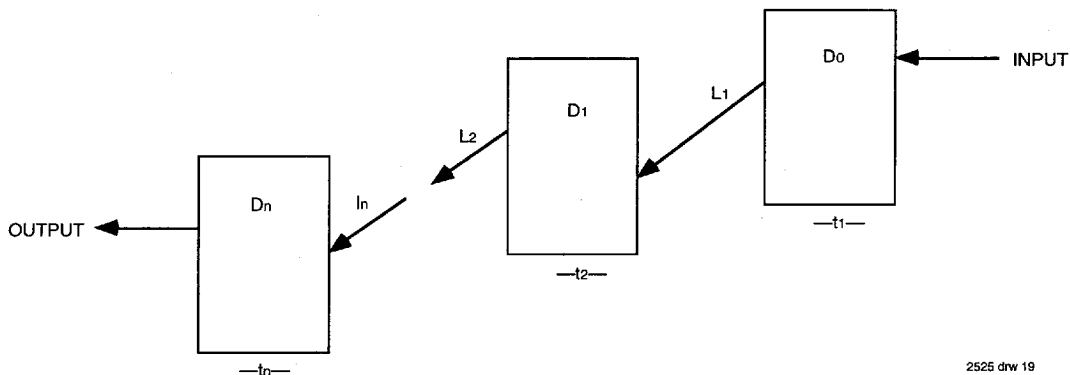


Figure 10. Propagation Delay = t₁ + t₂ + ... + t_n N-Cascaded Devices

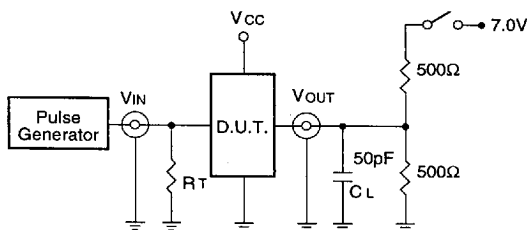
AC TEST CONDITIONS

Input Pulse Levels	GND to 3.0V
Input Rise/Fall Times	1V/ns
Input Timing Reference Levels	1.5V
Output Reference Levels	1.5V
Output Load	See Figure 1

2525 tbl 21

TEST CIRCUITS AND WAVEFORMS

TEST CIRCUITS FOR ALL OUTPUTS



2525 drw 09

SWITCH POSITION

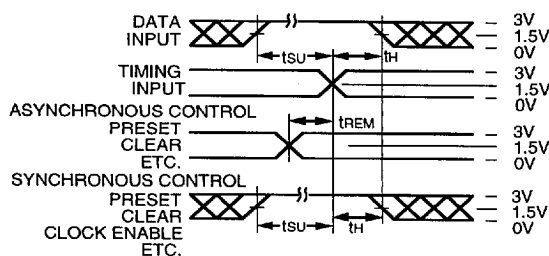
Test	Switch
Open Drain Disable Low Enable Low	Closed
All Other Tests	Open

DEFINITIONS:

CL = Load capacitance: includes jig and probe capacitance.
RT = Termination resistance: should be equal to ZOUT of the Pulse Generator.

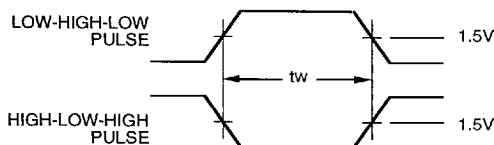
2525 ink 23

SET-UP, HOLD AND RELEASE TIMES



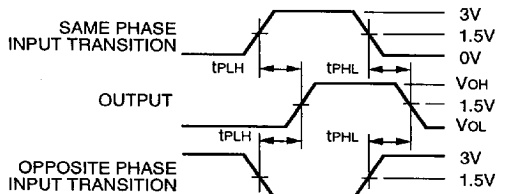
2525 drw 21

PULSE WIDTH



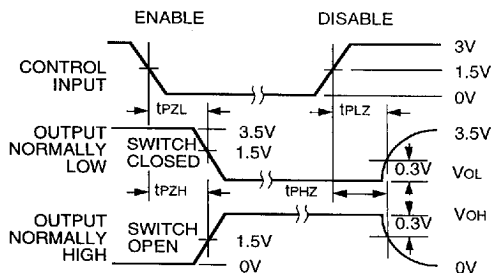
2525 drw 22

PROPAGATION DELAY



2525 drw 23

ENABLE AND DISABLE TIMES

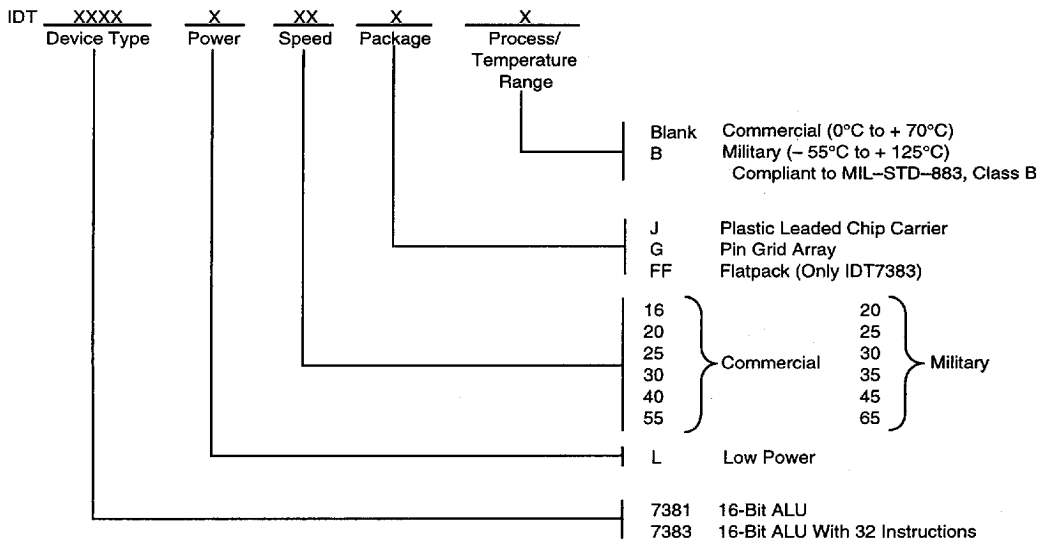


NOTES:

- Diagram shown for input Control Enable-LOW and input Control Disable-HIGH
- Pulse Generator for All Pulses: Rate $\leq 1.0\text{MHz}$; $t_r \leq 2.5\text{ns}$; $t_f \leq 2.5\text{ns}$

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ORDERING INFORMATION



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